© Copyright 200	mposition De 05. IPC, Bannock I Pan-American c	burn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declar he declaration	ation of the encompas	substance ses all low	s within the er level mat	manufacture terials for wh	er listed ite hich the ma	m. Note: nufactur	if the item is an a er has engineering	ssembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis								eous Materia	ials and Mfg Information				
Supplier Information														
Company name* Com			Company unique ID			Unique ID Authority					Response Date*			
onsemi											2025-07-17			
Contact Name Title - C			itle - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product			oduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Rep			Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Env			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Iten		n Number Mfr Item Name			Effective Da	te Versio	n	Manufacturing Site		W	eight*	UOM	Unit Type
	ADT747	73ARQZ-1RL	FAN CTRLR AND INT MON			2025-07-17			PH1		77	.0	mg	Each
Aanufacturing Proccess Infor	mation						I							
Terminal Plating / Grid Array Material Terminal Base .		Alloy	J-STD-020 MSL Rating		Peak Pre	Peak Process Body Temperatur		re Max Time at Peak Temperatu		Temperatur	e Nun	nber of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30		seconds	3		
omments														
vel 1 - maximum time at peak tempe	rature during so	dering is 10-3	0 seconds											
or more information regarding mate	rial composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.3	mg	Supplier	Silicon (Si)	7440-21-3		1.3	mg
Die Attach	0.31	mg	Supplier	Silver (Ag)	7440-22-4		0.2325	mg
			Supplier	Epoxy resins	129915-35-1		0.0775	mg
Lead Frame	31.11	mg	Supplier	Silver (Ag)	7440-22-4		0.4449	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0373	mg
			Supplier	Iron (Fe)	7439-89-6		0.7218	mg
			Supplier	Copper (Cu)	7440-50-8		29.8967	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0093	mg
Mold Compound-Black	43.0	mg		Epoxy Phenol Resin	proprietary data		4.515	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.485	mg
Plating	0.86	mg	Supplier	Tin (Sn)	7440-31-5		0.86	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg